



**THE DATASHEET OF
SDM160S1F-7**



Product Summary

| V_{RRM} (V) | I_o (A) | V_F Max (V) @ +25°C | I_R Max (mA) @ +25°C |
|---------------|-----------|--------------------------|---------------------------|
| 60 | 1 | 0.53 | 0.06 |

Features and Benefits

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Interlocking Clip Design for High Surge Current Capacity
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **An Automotive-Compliant Part is Available Under Separate Datasheet ([SDM160S1FQ](#))**

Description and Applications

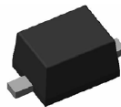
The SDM160S1F is a single rectifier packaged in SOD123F. Offering low V_F , low power loss and high efficiency, this device is ideal for use in general rectification applications as a:

- Boost Diode
- Blocking Diode

Mechanical Data

- Case: SOD123F
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Polarity: Cathode Band
- Weight: 0.015 grams (Approximate)

SOD123F



Top View

Ordering Information (Note 4)

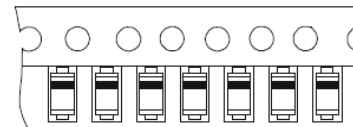
| Part Number | Case | Packaging |
|-------------|---------|-------------------|
| SDM160S1F-7 | SOD123F | 3,000/Tape & Reel |

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



D6 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex.: D = 2016)
 M = Month (ex.: 9 = September)
 Bar Denotes Cathode Pin



Bar Denotes Cathode Pin

Date Code Key

| Year | 2013 | 2014 | 2015 | 2016 | 2017 | 2018 | 2019 | 2020 |
|------|------|------|------|------|------|------|------|------|
| Code | A | B | C | D | E | F | G | H |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|---|------------------|-------|------|
| Peak Repetitive Reverse Voltage | V _{RRM} | 60 | V |
| Working Peak Reverse Voltage | V _{RWM} | | |
| DC Blocking Voltage | V _{RM} | | |
| Average Rectified Output Current | I _O | 1 | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | 50 | A |

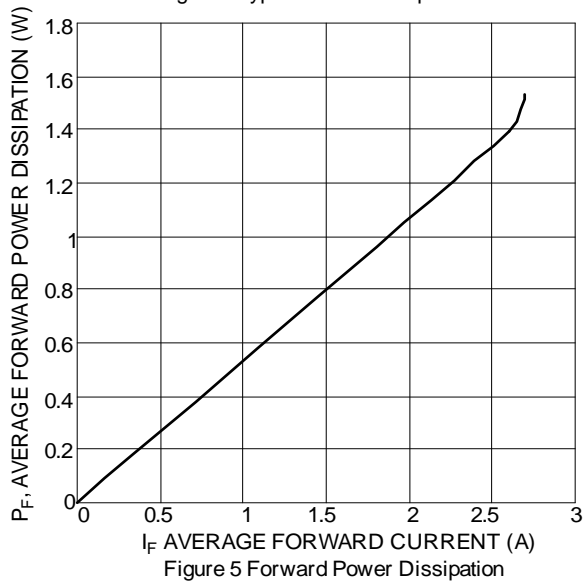
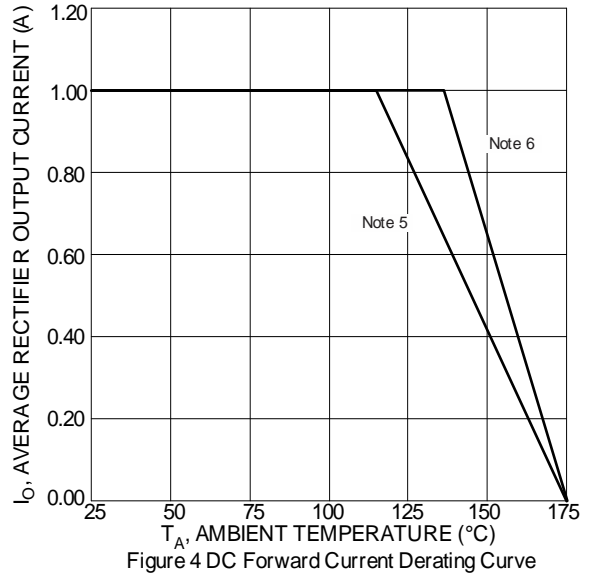
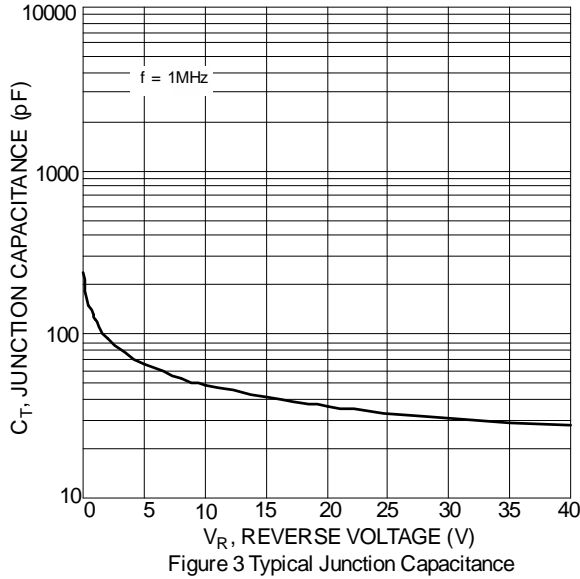
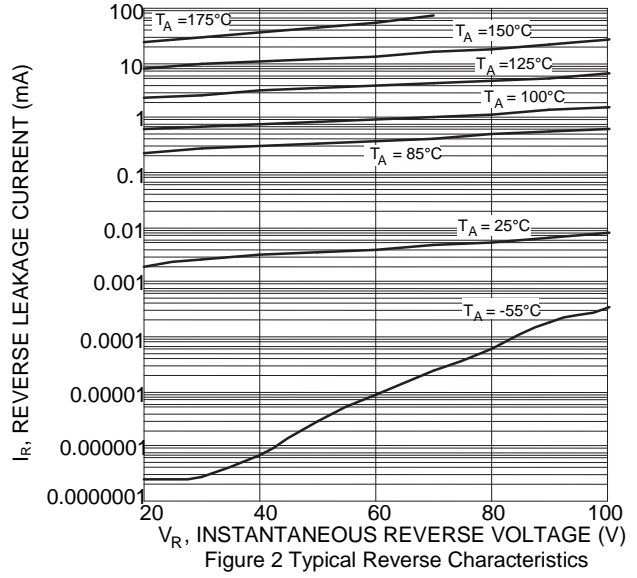
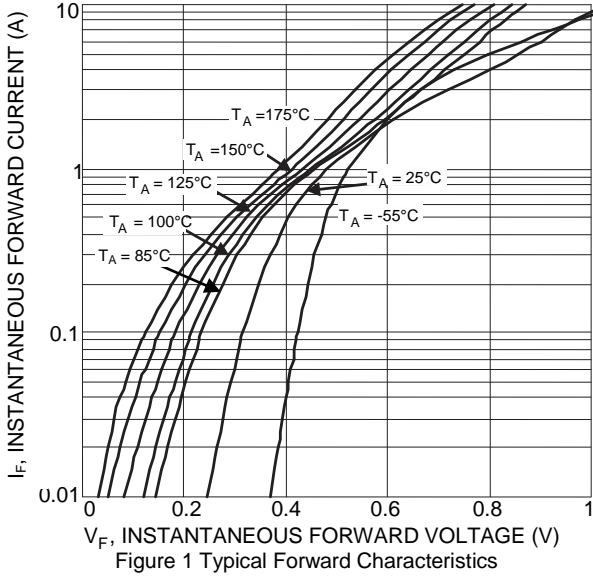
Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Typical Thermal Resistance Junction to Case (Note 5) | R _{θJC} | 40 | °C/W |
| Typical Thermal Resistance Junction to Ambient (Note 5) | R _{θJA} | 110 | |
| Typical Thermal Resistance Junction to Case (Note 6) | R _{θJC} | 8 | |
| Typical Thermal Resistance Junction to Ambient (Note 6) | R _{θJA} | 75 | |
| Typical Thermal Resistance Junction to Solder point (Note 6) | R _{θJS} | 18 | |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +175 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|------------------------------------|--------------------|-----|-------|-------|------|---|
| Reverse Breakdown Voltage (Note 7) | V _{(BR)R} | 60 | — | — | V | I _R = 1.0mA |
| Forward Voltage Drop | V _F | — | 0.32 | 0.37 | V | I _F = 0.1A, T _J = +25°C |
| | | — | 0.43 | 0.49 | | I _F = 0.7A, T _J = +25°C |
| | | — | 0.46 | 0.53 | | I _F = 1A, T _J = +25°C |
| Leakage Current (Note 7) | I _R | — | 0.002 | — | mA | V _R = 10V, T _J = +25°C |
| | | — | 0.010 | 0.060 | | V _R = 60V, T _J = +25°C |
| | | — | 0.40 | — | | V _R = 60V, T _J = +85°C |
| | | — | 3.7 | — | | V _R = 60V, T _J = +125°C |
| Total Capacitance | C _T | — | 48 | — | pF | V _R = 10V, f = 1MHz |

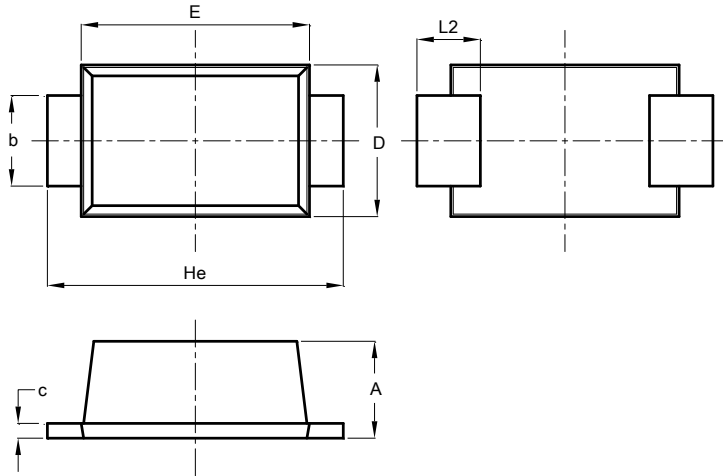
- Notes:
5. Device mounted on 1*MRP FR-4 PC board, 2oz.
 6. Device mounted on 1-inch sq. copper pad, 2oz.
 7. Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F

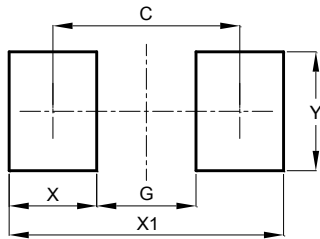


| SOD123F | | | |
|----------------------|------|------|------|
| Dim | Min | Max | Typ |
| A | 0.81 | 1.15 | - |
| b | 0.80 | 1.35 | - |
| c | 0.05 | 0.30 | - |
| D | 1.70 | 1.90 | 1.80 |
| E | 2.60 | 2.80 | 2.70 |
| He | 3.30 | 3.70 | 3.50 |
| L2 | 0.35 | 0.85 | - |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 2.86 |
| G | 1.52 |
| X | 1.34 |
| X1 | 4.20 |
| Y | 1.80 |

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